A Full Range of MIL-DTL-83513 Type Micro-D Hermetic Connectors

Product Applications
Glenair MIL-DTL-83513 type Micro-D hermetic connectors are ideal for high-pressure/low-leakage applications where size, weight and vibration resistance are a critical concern. Sophisticated electronics enclosures, vacuum chambers and cryogenic equipment all benefit from the airtight seal and moisture resistant plating found on Glenair hermetic Micro-D connectors. Solder mount, and rear panel O-ring shell styles are available to meet a variety of design requirements.

Materials
Kovar®—an iron nickel alloy—is used in both the shells and contacts, and provides a chemical bond with the glass insulator for maximum hermeticity. Shells are then plated with nickel after the glass insulator is fired to enhance corrosion resistance. Contacts are plated with gold to ensure superior electrical conductivity.

Connectors are offered with a minimum of 9 sockets, up to a maximum of 100 sockets—in two, three and four row solder cup and pigtail configurations. Fluorosilicon rubber interfacial seals and O-rings ensure positive sealing with plug connectors and panels. Gold plated Kovar® socket contacts boast superior vibration resistance when used in conjunction with Glenair’s innovative TwistPin contact system in the plug.

Same-Day Inventory
Because Glenair makes all its hermetic connectors in-house, including the machining of shells, molding of interfacial seals and firing of hermetic components, we can offer you outstanding availability on stock products and fast turnaround on special orders.

Catalog contents—including part numbers, materials and dimensions—are accurate to the best of our ability when we go to print. Even so, customers are advised to consult the factory for the latest specifications, particularly to confirm critical dimensions such as connector lengths, threads, and so on. Corrected content is posted immediately to www.glenair.com

Solder Mount and Rear Panel Sealing Options
9 to 100 Sockets in 9 Shell Sizes
Space Grade Special Screening Available
1 x 10⁻⁷ cc/Helium per Second Leakage Rate
Solder Cup, PC Tail and Pre-Wired Pigtail Termination Options
Machined Kovar® Shells and Contacts with Moisture Resistant Plating
Micro-D Hermetic Connectors

Hermeticity is defined as "the state or condition of being airtight". Sophisticated military electronics enclosures can experience electrical failure from ingress of moisture. System engineers can design the enclosure to withstand exposure to moisture and condensation by using "moisture-hardened" components and conformal coatings, but often the most practical approach is to install hermetically sealed electrical I/O connectors. Glass-to-metal seals provide assurance that, over the life of the enclosure, the accumulated amount of water vapor inside the box will not exceed the amount necessary to form condensation. Other applications for Micro-D hermetic connectors include vacuum chambers, cryogenics, and enclosures filled with inert gas.

Kovar® Alloy
Glenair’s hermetic Micro-D shells and contacts are made from a special alloy called Kovar®, an iron-nickel-cobalt alloy consisting of 54% Fe, 29% Ni, and 17% Co. This alloy is covered by SAE specification AMS-I-23011. Kovar has a relatively low coefficient of thermal expansion.

Micro-D Hermetic Plating Options
Unlike regular connectors which are plated as components prior to assembly, hermetic connectors are electroplated after the parts are fired and cleaned of oxides. Typically the contacts are gold-plated and the connector shell is nickel-plated.

Matched Glass-To-Metal Seals
Matched seals rely on a chemical bond between the metal and the glass. Kovar contacts and shells are first exposed to high temperatures in order to develop an oxide coating. Then, the borosilicate glass and metal components are assembled with fixtures and are fused in a firing furnace at 900°C. A strong chemical bond is created between the metal and glass. Unlike compression seals which rely on different thermal coefficients of expansion between the glass and metal, a matched seal offers better resistance to stress from thermal extremes.

Connector Installation
Hermetic connectors are typically soldered or welded into panels or bulkheads. Laser welding is a good option if the connector is mounted onto a Kovar or stainless steel panel. If the panel is aluminum alloy, then soldering is recommended. Micro-D’s with o-ring seals offer another alternative. O-rings, when installed properly, will provide a very low permeability seal. The seating surface must be free from scratches or imperfections. A 32 finish is acceptable, but a 16 finish is preferred. The o-ring can be coated with a light coat of vacuum grease.

Hermetic Testing
All Micro-D hermetic connectors are 100% tested prior to shipment. A helium leak test is performed to certify the hermetic seal. This test is conducted by inducing a 1 ATM vacuum on one side of the connector. Helium gas is released on the other side, and a mass spectrometer "counts" the number of helium molecules that penetrate the connector seal. Helium leak testing takes advantage of the small size of a helium molecule compared to air or water vapor. Helium is inert, rare in our atmosphere, and is easy to detect with a mass spectrometer.
Micro-D Hermetic Connector Design Notes

“Why can’t I get a hermetic Micro-D with pin contacts instead of sockets?”

The Micro-D TwistPin contact cannot be made from the materials that are required for hermetic contacts. Hermetic contacts are made from ferrous alloys such as Kovar® or Alloy 52. These alloys do not have spring properties. The Micro-D TwistPin contact is made from spring-temper beryllium copper. The Micro-D socket contact is a cylinder and does not provide any spring force, so Micro-D hermetic connectors are always receptacle connectors with socket contacts.

“What about high pressure?”

“What is the maximum recommended pressure rating for a hermetic Micro-D and can I get a lower leak rate?”

Glenair hermetic Micro-D’s are built to safely withstand 1000 PSI of hydrostatic pressure in an open face (unmated) condition. Use Modification 585 for lower leak rates.
Micro-D Hermetic Connectors
General Information

MICRO-D PCB FOOTPRINTS (COMPONENT SIDE OF BOARD)

9 Socket

21 Socket

31 Socket

51 Socket (Standard 3 Row)

100 Socket

Connector Weights For 177-140H Hermetic Solder Mount

<table>
<thead>
<tr>
<th>Layout</th>
<th>Solder Cup</th>
<th>PCB</th>
</tr>
</thead>
<tbody>
<tr>
<td>9</td>
<td>4.7</td>
<td>4.5</td>
</tr>
<tr>
<td>15</td>
<td>7.1</td>
<td>6.8</td>
</tr>
<tr>
<td>21</td>
<td>8.2</td>
<td>8.0</td>
</tr>
<tr>
<td>25</td>
<td>8.7</td>
<td>8.4</td>
</tr>
<tr>
<td>31</td>
<td>9.5</td>
<td>9.2</td>
</tr>
<tr>
<td>37</td>
<td>10.8</td>
<td>10.4</td>
</tr>
</tbody>
</table>

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<thead>
<tr>
<th>Hermetic Leak Rate Mod Codes</th>
</tr>
</thead>
<tbody>
<tr>
<td>Designator</td>
</tr>
<tr>
<td>------------</td>
</tr>
<tr>
<td>–585A</td>
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<td>–585B</td>
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<td>–585C</td>
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